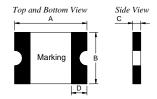
1. Physical Dimensions(size of 1206)

Unit:mm

Part Number	A		В		С		D	Montrino	
	Min	Max	Min	Max	Min	Max	Min	Marking	
K1206L035/16YR	3.00	3.40	1.40	1.80	0.60	1.00	0.25	T04	



2, Electrical Characteristics

Part Number	I _H (A)	I _T (A)	V _{max} (V)	I max (A)	$\begin{array}{c c} & T_{trip} \\ \hline (Max time to trip) \\ \hline Current(A) & Time(S) \\ \end{array}$		Pd _{typ} (W)	R_{min} (Ω)	$R1_{max}$ (Ω)
K1206L035/16YR	0.35	0.75	16	40	8.00	0.10	0.60	0.300	1.200

I_H: Holding Current: maximum current at which the device will not trip in 25 ℃ still air.

 I_T : Tripping Current minimum current at which the device will trip in 25 $^{\circ}$ C still air.

V_{max}: Maximum voltage device can withstand without damage at rated current.

I max: Maximum fault current device can withstand without damage at rated voltage.

T trip: Maximum time to trip(s) at assigned current.

Pd_{typ}: Rated working power.

R $_{\text{min}}$: Minimum resistance of device prior to trip at 25 $^{\circ}\text{C}$.

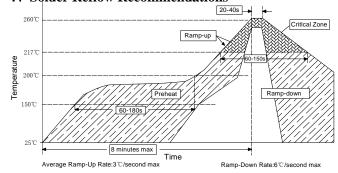
R1 $_{max}$: Maximum resistance of device is measured one hours post reflow at 25 $^{\circ}$ C.

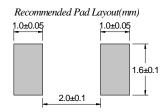
Noted: All electrical function test is conducted after PCB mounted.

3. Thermal Derating

K1206L035/16YR	Maximum ambient operating temperature									
	-40°C	-20°C	0℃	25℃	40℃	50℃	60°C	70°C	85℃	
Hold Current(A)	0.51	0.46	0.40	0.35	0.30	0.27	0.24	0.22	0.18	
Trip Current(A)	1.09	0.99	0.86	0.75	0.64	0.58	0.51	0.47	0.39	

4. Solder Reflow Recommendations





Notes:If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

5. Package Information

Packing quantity: 4000 PCS/Reel

Note: Reel packaging per EIA-481-1 standard

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